

## **QUALITEK®**

# **Delta**\*Elite\*\*

### 818 Solder Paste, Low Residue, No-Clean

#### **Description**

818 No-Clean is a low residue solder paste designed for surface mount and other electronic assembly applications. The unique properties of this formula provide excellent activity. long stencil life, long tack time, high print speed and a longer shelf life. Post Soldering residues are transparent, non-corrosive

#### **BENEFITS**

- **Bellcore** compliant
- 24 hour stencil life
- 48 hour tack time
- **Excellent wetting on OSP**
- Non-corrosive
- Prints up to 200mm per sec.
- Low residue
- Air or nitrogen Reflow

#### **APPLICATION**

#### PRINTING / PARTICLE SIZE

> 50 mil pitch: Use -200 + 325 mesh > 16 mil pitch: Use -325 +500 mesh < 16 mil pitch: Use –400 +635 mesh

ALLOYS

Sn63/Pb37, Sn62/Pb36/Ag2, etc. (Meets J-STD-006 Specification)

METAL CONTENT

Stencil Printing: 90% Screen Printing: 88%

#### REFLOW PROFILE

The melting temperature of the solder and the heat resistance of components determine reflow Profile. 818 can be processed in most reflow media, (i.e. IR, Vapor-phase, Forced convection, etc.). Ramp rate of 2.5-3.0°C per second is desirable, since most components are rated for 4.0°C per second.

#### PHYSICAL / CHEMICAL CHARACTERISTICS

**Color and Appearance** Metallic Gray Pass/No Breakthrough **Copper Mirror Test** Silver Chromate (Chloride & Bromide Pass/ No discoloration

Test)

Surface Insulation Resistance-Ohms

Classification RELO

9.8 x 10<sup>12</sup> ohms (7 days, 85C, 85% R.H.) J-STD-004 Bellcore 4.12 X 10 ohms (7 days, 85C, 85% RH.)

**Electromigration Bellcore** pH-5% Aqueous Solution (Flux Extract) 3.0 - 5.0125°C **Softening Point** 

Viscosity

Malcom<sup>1</sup> 140-200 kcps, 90% metal, (-325+500 mesh) Brookfield<sup>2</sup> 900 kcps +/- 10%, 90% metal, (-325+500 mesh)

**Tack Time** 48 Hours (22C, 45% RH.)

#### SHIPPING & STORAGE

Recommended Storage Temperature 35°-50°F

**SHELF LIFE** 

**Unopened Container** 35°-65°F 9 Months (from DOM)  $77^{\circ}F$ 1 Months (from DOS)

- 1. Malcom PCU-Series, 10 RPM, 25°C
- Brookfield RVTD, TF spindle, 5 RPM, 25°C,0.75" spindle depth
- Bellcore GR-78-CORE

**Delta Elite**<sup>®</sup> is a registered trademark of Qualitek International, Inc.

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Rev. 120902-818 Consult MSDS for health and safety information

# 818 PROFILE

